

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Russ Reisner	03/31/2008
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Skyworks Solutions, Inc.
<b>Street Address:</b>	20 Sylvan Road
<b>City:</b>	Woburn
<b>State/Country:</b>	MASSACHUSETTS
<b>Postal Code:</b>	01801
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	12156988
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(949)282-1002
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
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<b>ATTORNEY DOCKET NUMBER:</b>	0140173
<b>NAME OF SUBMITTER:</b>	Michael Farjami
<b>Total Attachments: 2</b>	
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ASSIGNMENT

WHEREAS, I/WE:

INVENTOR NAME	INVENTOR RESIDENCE ADDRESS
Russ Reisner	4430 Camino De La Rosa, Newbury Park, CA 91320

have invented certain new and useful improvements disclosed in an application for United States Letters Patent titled **Semiconductor Die with Backside Passive Device Integration**, filed herewith, or filed on 6/6/2008, Serial No. 12/156,988, and identified by Docket No. 0140173 in the offices of FARJAMI & FARJAMI LLP;

AND WHEREAS SKYWORKS SOLUTIONS, INC., a Delaware corporation (hereinafter, together with any successors, legal representatives and assigns thereof, called "Assignee"), wants to acquire the entire right, title, and interest in and to said improvements and application:

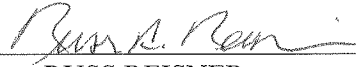
NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I/WE have sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to Assignee the entire right, title, and interest in and to said improvements, and said application and all divisions, substitutions, continuations and continuations-in-part thereof, and all United States Letters Patents which may be granted thereon and all reissues and extensions thereof, and all priority rights under the International Convention for the Protection of Industrial Property for every member country, and all applications for patents (including related rights such as utility-model registrations, inventor(s) certificates, and the like), heretofore or hereafter filed for said improvements in any foreign countries, and all patents (including all extensions, renewals, and reissues thereof) granted for said improvements in any foreign countries; and I/WE hereby authorize and request the United States Commissioner of Patents and Trademarks, and any officials of foreign countries whose duty it is to issue patents on applications as aforesaid, to issue all patents for said improvements to Assignee in accordance with the terms of this assignment;

AND I/WE HEREBY covenant that I/WE have full right to convey the entire interest herein assigned, and that I/WE have not executed, and will not execute, any agreement in conflict herewith;

AND I/WE HEREBY further covenant and agree that I/WE will communicate to Assignee any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, continuations-in-part, substitute and reissue applications, make all rightful oaths, and generally do everything possible to aid Assignee to obtain and enforce proper patent protection for said improvements in all countries;

AND I/WE HEREBY authorize the attorneys of record in said application to insert in this assignment the filing date and serial number of said application when officially known.

IN TESTIMONY WHEREOF, I hereunto set my hand this 31 day of MARCH, 2008.



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RUSS REISNER